April 2001



FDD6644/FDU6644

30V N-Channel PowerTrench[®] MOSFET

General Description

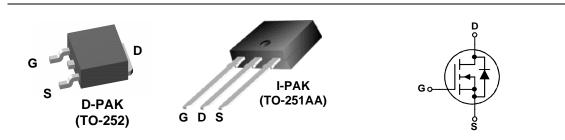
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $R_{DS(ON)}$ and fast switching speed.

Applications

• DC/DC converter

Features

- 67 A, 30 V. $R_{DS(ON)} = 8.5 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$ $R_{DS(ON)} = 10.5 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- Low gate charge (25 nC typical)
- High power and current handling capability



Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		30	V
V _{GSS}	Gate-Source Voltage		±16	V
ID	Drain Current – Continuous	(Note 1a)	67	A
	– Pulsed		100	
P _D	Maximum Power Dissipation	(Note 1)	68	W
		(Note 1a)	3.8	
		(Note 1b)	1.6	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +175	°C
Therma	I Characteristics			
R _{θJC}	Thermal Resistance, Junction-to-Case	(Note 1)	2.2	°C/W
Reia	Thermal Resistance, Junction-to-Ambient	(Note 1b)	96	°C/W

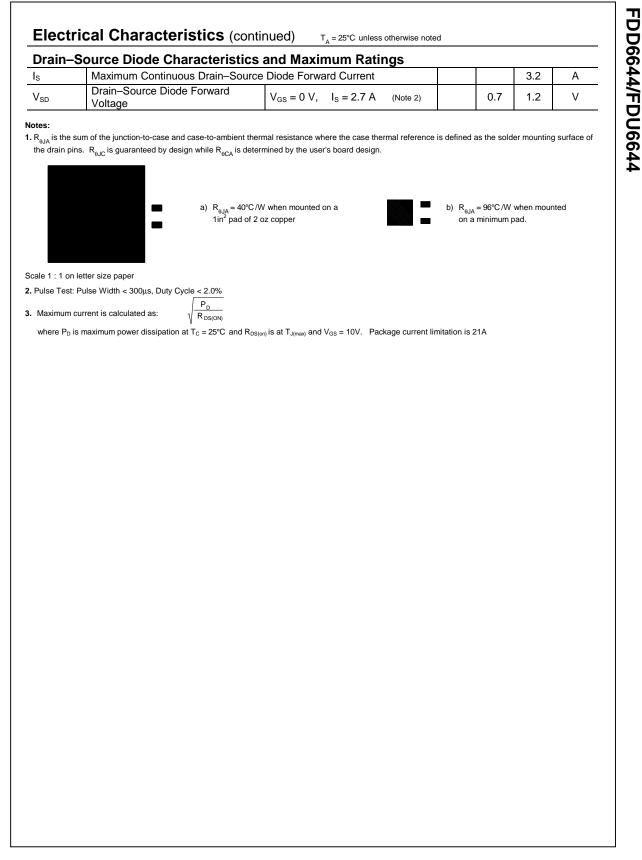
Package Marking and Ordering Information

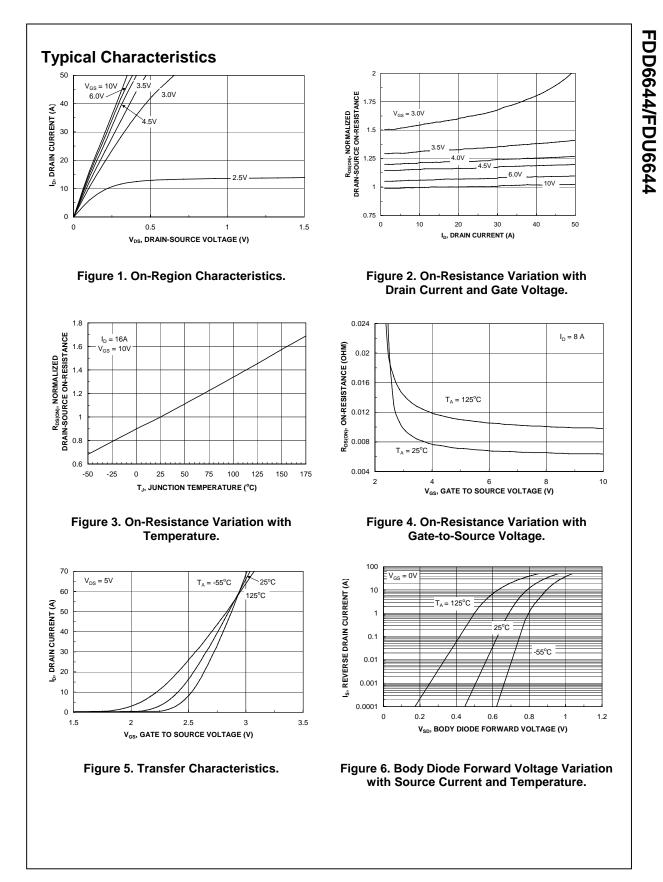
Device Marking	Device	Package	Reel Size	Tape width	Quantity
FDD6644	FDD6644	D-PAK (TO-252)	13"	12mm	2500 units
FDU6644	FDU6644	I-PAK (TO-251)	Tube	N/A	75

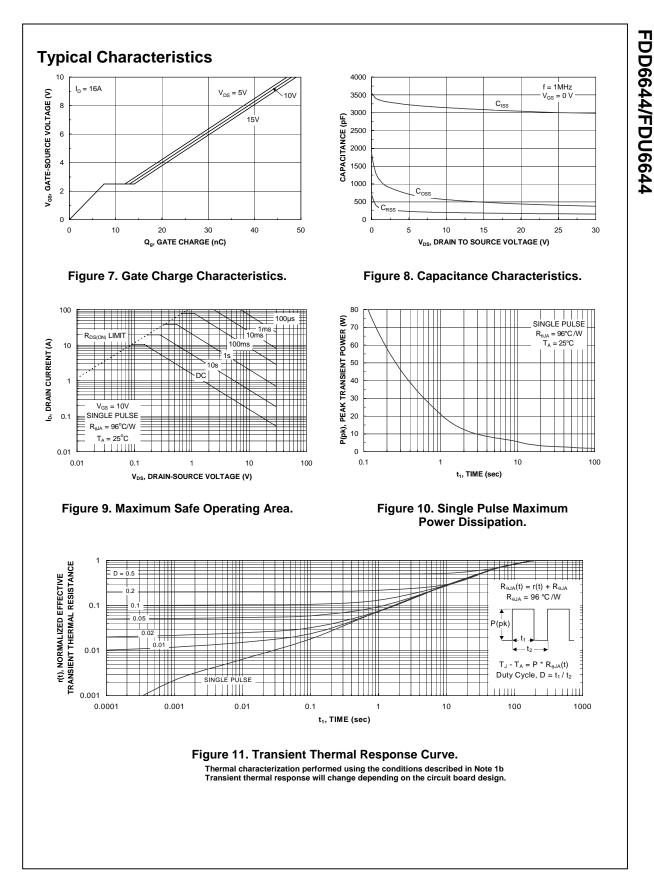
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	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-So	burce Avalanche Ratings (Not	e 2)		1	1	L
W _{DSS}	Drain-Source Avalanche Energy	Single Pulse, $V_{DD} = 15 \text{ V}$, $I_D = 17 \text{ A}$			240	mJ
I _{AR}	Drain-Source Avalanche Current				17	А
Off Char	acteristics	•				
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$	30			V
<u>ΔBV_{DSS}</u> ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C		27		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$			1	μA
	Gate-Body Leakage, Forward	V _{GS} = 16 V, V _{DS} = 0 V			100	nA
GSSR	Gate-Body Leakage, Reverse	$V_{GS} = -16 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
On Char	acteristics (Note 2)	•				
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1	1.5	3	V
$\Delta V_{GS(th)}$ ΔT_J	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		-5	-	mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = 10 \ V, \ I_D = 16 \ A \\ V_{GS} = 4.5 \ V, \ I_D = 15 \ A \\ V_{GS} = 10 \ V, \ I_D = 16.5 A, T_J = 125^\circ C \end{array} $		6.5 7.5 10	8.5 10.5 13	mΩ
I _{D(on)}	On–State Drain Current	$V_{GS} = 10 \text{ V}, V_{DS} = 5 \text{ V}$	50			А
g fs	Forward Transconductance	$V_{\text{DS}} = 5 \text{ V}, \qquad I_{\text{D}} = 16 \text{ A}$		74		S
Dvnamic	Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = 15 V$, $V_{GS} = 0 V$,		3087		pF
C _{oss}	Output Capacitance	f = 1.0 MHz	-	489		pF
C _{rss}	Reverse Transfer Capacitance			185		pF
Switchin	g Characteristics (Note 2)	•	•			
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 15 V, I_D = 1 A,$		10	20	ns
t _r	Turn–On Rise Time	$V_{GS} = 10$ V, $R_{GEN} = 6 \Omega$		12	22	ns
t _{d(off)}	Turn–Off Delay Time	-		48	77	ns
tr	Turn–Off Fall Time	-		10	20	ns
Qg	Total Gate Charge	$V_{DS} = 15 \text{ V}, I_D = 16 \text{ A},$		25	35	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 5 V$		7.5		
Q _{gd}	Gate–Drain Charge			6.5		

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	1	Rev. H1